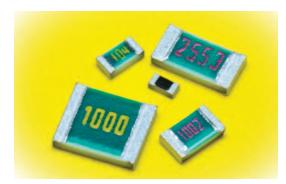




thin (metal) film flat chip resistors



features

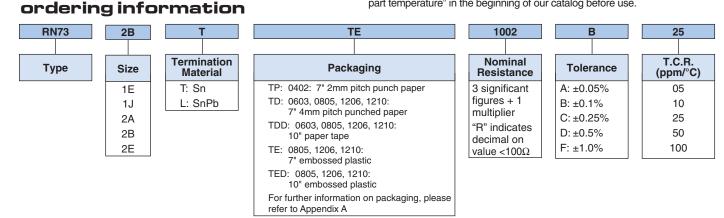
- Nickel chromium thin film resistor element
- Products with lead-free terminations meet
- EU RoHS requirements

dimensions and construction С <u>≁</u>− C Solder Plating Ni lating Protective d Resi Inner Electrode Coating Film Ceramic Substrate **Derating Curve** 100 80 % Rated Power 60 40 20 0 ⊥ -60▲ -55 -40 -20 0 20 40 60 * 80 100 120 140 70 , 155 Ambient Temperature (°C)

Туре	Dimensions inches (<i>mm</i>)							
(Inch Size Code)	L	W c		d	t			
RN73 1E (0402)	.039 +.004 002 (1.0 +0.1 -0.05)	.02±.002 (0.5±0.05)	.008±.004 (0.2±0.1)	.01 +.002 004 (0.25 +0.05 -0.1	.014±.002 (0.35±0.05)			
RN73 1J (0603)	.063±.008 (1.6±0.2)	.031±.004 (0.8±0.1)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.018±.004 (0.45±0.1)			
RN73 2A (0805)	.079±.008 (2.0±0.2)	.049±.008 (1.25±0.2)	.016±.008 (0.4±0.2)	.012 +.008 004 (0.3 +0.2 -0.1)	.02±.004 (0.5±0.1)			
RN73 2B (1206)	.126±.008	.063±.008 (1.6±0.2)	.02±.012	.016 +.008	.024±.004			
RN73 2E (1210)	(3.2±0.2)	.098±.008 (2.5±0.2)	(0.5 ± 0.3)	(0.4 +0.2)	(0.6±0.1)			
100 80 1 100 1 100 1 100 100 10								
-55 75 85 95 155 Terminal Part Temperature (°C)								

For resistors operated at an ambient temperature of 70° C or above, a power rating shall be derated in accordance with the above derating curve.

For resistors operated terminal part temperature of described for each size or above, a power rating shall be derated in accordance with derating curve. Please refer to "Introduction of the derating curves based on the terminal part temperature" in the beginning of our catalog before use.



Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

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KOA SPEER ELECTRONICS, INC.

thin (metal) film flat chip resistors

applications and ratings

Part Designation	Power @ 7		Ambient Terminal (ppm)		(ppm/°C)	Resistance Range (Ω) E-24, E-96, E-192*				Max.	Absolute Max. Overload	
Designation	General		Temp.	Temp.		(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage
RN731E	.063W	_	70°C	75°C	±25	—	100 - 100k	100 - 100k	10 - 120k	10 - 120k	50V	100V
THUISTE	.00377				±50	—	100 - 100k	100 - 100k	10 - 120k	10 - 120k		1000
					±5	1K - 47k	100 - 47k	_				
RN731J .063W .1W		70°C	75°C	±10	1K - 47k	100 - 47k	100 - 47k	100 - 47k	100 - 47k	75V	150V	
	.1W			±25	1K - 47k	15 - 360k	15 - 360k	10 - 360k	10 - 360k			
			±50		15 - 360k	15 - 360k	10 - 360k	10Ω - 360k	-			
			±100		—	—	10 - 360k	10 - 360k				
RN732A .1W .12				±5	100 - 100k	100 - 100k	—					
		IW .125W	70°C	80°C	±10	100 - 100k	100 - 100k	100 - 100k	100 - 100k	100 - 100k	150V	300V
	.1W				±25	51 - 100k	15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±50	_	15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±100	_	-	_	10 - 1M	10 - 1M		
				±5	100 - 300k	100 - 300k						
					±10	100 - 300k	100 - 300k	100 - 300k	100 - 300k	100 - 300k		
RN732B .125W	.25W	70°C	85°C	±25	51 - 300k	15 - 1M	15 - 1M	10 - 1M	10 - 1M	200V	400V	
					±50		15 - 1M	15 - 1M	10 - 1M	10 - 1M		
					±100		_	—	10 - 1M	10 - 1M		
					±10	100 - 510k	100 - 510k	100 - 510k	100 - 510k	100 - 510k		
RN732E	RN732E .25W — 70°C	-	70°C	95°C	±25	51 - 510k	15 - 1M	15 - 1M	10 - 1M	10 - 1M	200V	400V
					±50		15 - 1M	15 - 1M	10 - 1M	10 - 1M		
				±100	_			10 - 1M	10 - 1M			

* No marking on E-192 values Operating Temperature Range: -55°C to +155°C ¹ Reliability performance is different. Please confirm the performance table. If any questions should arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature", please give priority to the "Rated Terminal Part Temperature". Prior to use and for more details refer to "Introduction of the derating curves on the terminal part temperature" in the beginning of the catalog.

environmental applications

Performance Characteristics

	Requirement A	R ±(%+0.05Ω)				
Parameter	Limit	Typical	Test Method			
Resistance	Within specified tolerance	—	25°C			
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R. = ±5 (X10 ⁻⁶ /K) +25°C/-55°C and +25°C/+125°C: all others			
Overload (Short time)	General: ±0.1%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less for 5 sec			
	High Power: ±0.5%	±0.03%				
Resistance to Solder Heat	±0.1%	±0.04%	$260^{\circ}C \pm 5^{\circ}C$, 10 seconds \pm 1 second			
Rapid Change of Temperature	±0.25%	±0.03%	-55°C (30 minutes), +125°C (30 minutes), 300 cycles			
Moisture Resistance	General: ±0.5%	±0.06%	40%0 x 0%0 00% 05% DU 1000 hours 1 5 hr ON 0 5 hr OFF such			
	High Power: ±0.5%	±0.07%	$40^{\circ}C \pm 2^{\circ}C$, 90%-95% RH, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle			
Endurance at 70°C	General: ±0.25%	±0.02%	70°C ± 2°C, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle			
	High Power: ±0.5%	±0.1%				
High Tomporatura Exposure	±0.25%	±0.1%	+125°C, 1000 hours			
High Temperature Exposure	±0.5%	±0.25%	+155°C, 1000 hours			

Precautions for Use

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1kV and more: 1J, 2A, 2B, 2E 0.5kV and more: 1E, Human Body Model 100pF 1.5kΩ) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive static electricity when mounting on the boards.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na), chlorine (CI-) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrical corrosion.
- The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistors and then detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the adhesives on the tape do not directly come in contact with the product.
- When high-pressure shower cleaning is implemented, there is a possibility of exfoliation of the top electrodes caused by the water pressure stress so please avoid the implementation.
- If the implementation is unavoidable, then please evaluate the products beforehand.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 9/30/19